

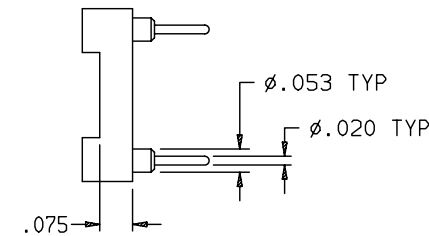
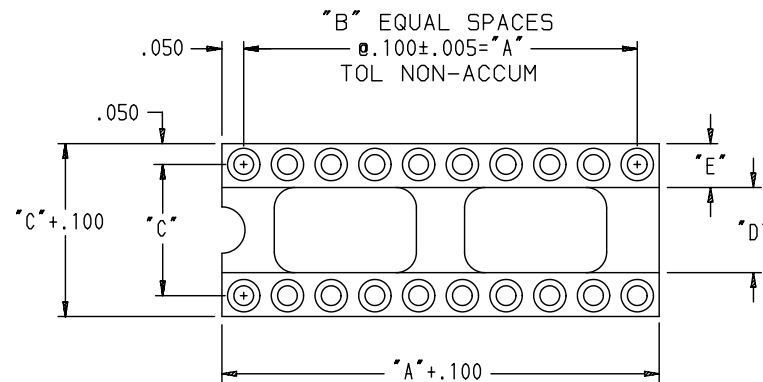
TABLE 2: LEAD FREE VERSION

TABLE 2 CONTACTS

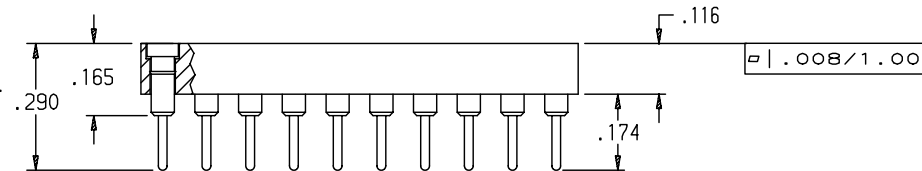
[XXX]BLF	CLIP PLATING	SHELL PLATING	PCB HOLE
001BLF	30u" GOLD OVER 50u" NICKEL	200u" TIN OVER 100u" NICKEL	Ø.026±.003
002BLF	30u" GOLD OVER 50u" NICKEL	10u" GOLD OVER 100u" NICKEL	Ø.026±.003
011BLF	10u" GOLD OVER 50u" NICKEL	200u" TIN OVER 100u" NICKEL	Ø.026±.003
014BLF	100u" TIN OVER 50u" NICKEL	200u" TIN OVER 100u" NICKEL	Ø.026±.003

TABLE 1

PART NUMBER		DIMENSION				
DIP-[]-[]-[XXX]B(LF)		"A"	"B"	"C"	"D"	"E"
306		.200	2	.300	.195	.100
308		.300	3			
314		.600	6			
316		.700	7			
318		.800	8			
320		.900	9			
322		1.000	10			
324		1.100	11			
328		1.300	13			
624		1.100	11	.600	.420	.140
628		1.300	13			
632		1.500	15			
640		1.900	19			
648		2.300	23			



NOTES:

1. PRODUCT NUMBERING CODE:
DIP-NNN-XXXJBTOTAL NO. OF POSITIONS.
ROW TO ROW SPACING.2. INSULATOR MATERIAL:
GLASS FILLED POLYESTER (PCT),
RATED UL 94V-0, COLOR BLACK.3. CONTACT MATERIAL:
OUTER SHELL: BRASS ALLOY 360, 1/2 HARD PER QQ-B-626.
INNER CONTACT: BERYLLIUM COPPER, ALLOY 172 PER QQ-C-533.4. CONTACT PLATING:
GOLD PER MIL-G-45204, TYPE 1
GRADE C, NICKEL PER QQ-N-290.
TIN/LEAD OR LEAD-FREE PER MIL-P-81728, TYPE 1

(DIP-320-[XXX]B SHOWN)

LEAD FREE PART NUMBER (SEE TABLE2)
DIP-[]-[]-[XXX]BLF

NOTE RoHS INFORMATION

- The "LF" products meet European Union Directives and other country regulations as described in GS-22-008.
- The housing will withstand exposure to 260°C peak temperature for 20 seconds in a wave solder application with a 1.6mm minimum thick circuit board. See application notes/procedures if they are available.
- Packaging spec: see GS-14-920

rev	ecr no	dr	date
A	V00857	DLW	4/5/00
B	D10009	TB	7/5/01
C	V05-0424	TAB	5/10/05
D	LS06-0004	LGO	17/01/06
E	LS07-0141	HLE	2007/05/21
F	LS07-0271	HLE	2007/10/29
-	-	-	-

www.fciconnect.com			surface ISO 1302		tolerance std ISO 406 ISO 1101		projection 		mm 		
TOLERANCES UNLESS OTHERWISE SPECIFIED											
Dr	D. WOLFORD	4/5/00	ANGULAR	LINEAR	0.X ±0.1		size A3	Scale 35:1			
Eng	A. VASBINDER	4/5/00			0.XX ±0.1						
Chr	A. VASBINDER	4/5/00			0.XXX ±0.1						
Appr	A. VASBINDER	4/5/00	0.XX' ±2"		0.XXX ±0.1		ECN		LS07-0271		
			Product family				DIP		Spec ref -		
			title DIP SOCKETS				dwg no 58708		Rev. F		
1			.100 C/L				CUSTOMER		sheet 1 of 1		
9			catalog no -								